



Mini-Circuits

ULTRA-SMALL CERAMIC

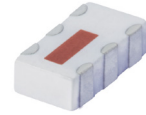
Power Splitter/Combiner

QCN-8+

2 Way-90° 50Ω 450 to 750 MHz

FEATURES

- Low insertion loss, 0.6 dB typ.
- Wrap-around terminal for excellent solderability
- Ultra small, 0.12"X0.06"X0.035"



Generic photo used for illustration purposes only

CASE STYLE: FV1206-1

APPLICATIONS

- Balanced amplifiers
- Modulators
- UHF
- Point to point radio

+RoHS Compliant

The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

ELECTRICAL SPECIFICATIONS AT +25°C

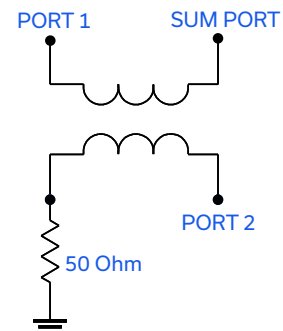
Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Frequency Range		450		750	MHz
Insertion Loss, above 3.0 dB	450-750		0.6	0.9	dB
	470-700		0.5	0.8	
Isolation	450-750	13	16		dB
	470-700	13	16		
Phase Unbalance	450-750		5	8	Degree
	470-700		5	8	
Amplitude Unbalance	450-750		0.5	1.0	dB
	470-700		0.3	0.8	
VSWR	450-750		1.4		(:1)
	470-700		1.4		

ABSOLUTE MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-55°C to +100°C
Storage Temperature	-55°C to +100°C
Power Input (as a splitter)	15 W* max.

* Derate linearly to 7 W at +100°C ambient.
Permanent damage may occur if any of these limits are exceeded.

ELECTRICAL SCHEMATIC



Mini-Circuits

www.minicircuits.com P.O. Box 350166, Brooklyn, NY 11235-0003 (718) 934-4500 sales@minicircuits.com

REV. E
ECO-025912
QCN-8+
ED-11876D/1
MCL NY
250702
PAGE 1 OF 3



Mini-Circuits

ULTRA-SMALL CERAMIC

Power Splitter/Combiner

QCN-8+

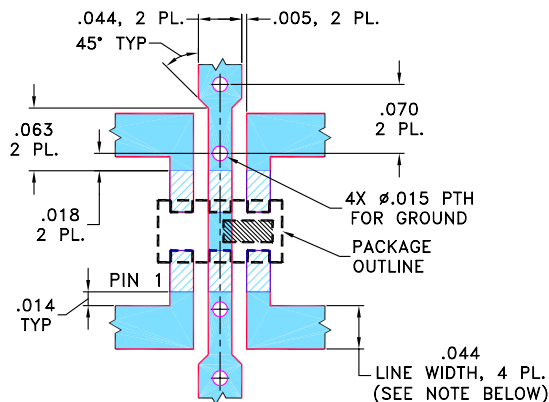
2 Way-90° 50Ω 450 to 750 MHz

PIN CONNECTIONS

SUM PORT	1
PORT 1 (0°)	4
PORT 2 (+90°)	6
GROUND	2,5
50 OHM TERM EXTERNAL	3

PRODUCT MARKING: N/A

DEMO BOARD MCL P/N: TB-QCN-8+
SUGGESTED PCB LAYOUT (PL-131)

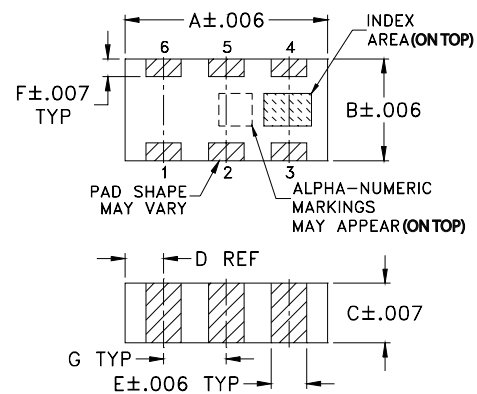


NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS $0.020" \pm 0.0015"$; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

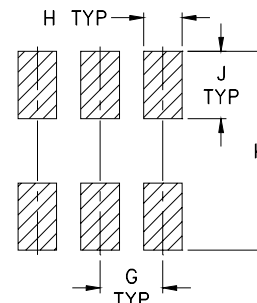
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

-  DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
-  DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

OUTLINE DRAWING



PCB Land Pattern



Suggested Layout,
Tolerance to be within ± 0.002

OUTLINE DIMENSIONS (Inches/mm)

A	B	C	D	E	F
.126	.063	.035	.024	.022	.011
3.20	1.60	0.89	0.61	0.56	0.28
G	H	J	K		wt
.039	.024	.042	.123		grams
0.99	0.61	1.07	3.12		.020

TAPE & REEL INFORMATION: F75





Mini-Circuits

ULTRA-SMALL CERAMIC

Power Splitter/Combiner

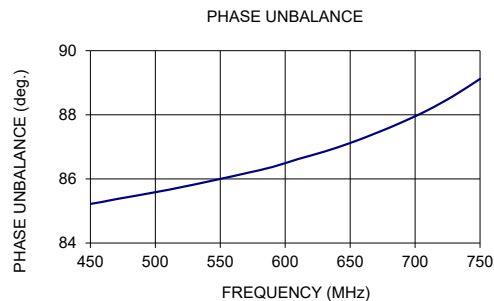
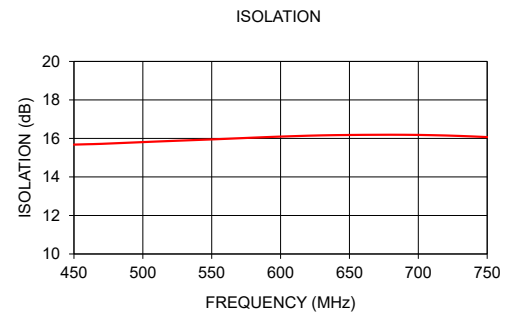
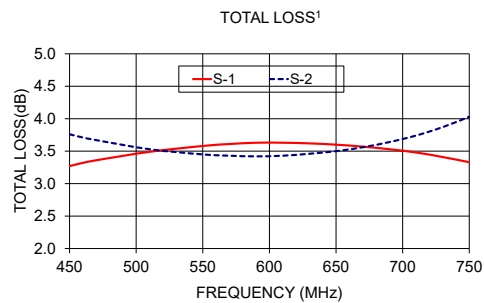
QCN-8+

2 Way-90° 50Ω 450 to 750 MHz

TYPICAL PERFORMANCE DATA

Frequency (MHz)	Total Loss ¹ (dB)		Amplitude Unbalance (dB)	Isolation (dB)	Phase Unbalance (deg.)	VSWR (:1)		
	S-1	S-2				S	1	2
450	3.27	3.76	0.49	15.68	85.22	1.41	1.41	1.38
460	3.32	3.71	0.40	15.70	85.29	1.40	1.41	1.38
470	3.36	3.67	0.31	15.72	85.37	1.40	1.41	1.37
510	3.49	3.53	0.04	15.84	85.66	1.39	1.40	1.36
550	3.58	3.45	0.13	15.95	86.00	1.37	1.40	1.36
570	3.61	3.43	0.18	16.01	86.18	1.37	1.40	1.36
590	3.63	3.42	0.20	16.07	86.37	1.36	1.40	1.36
610	3.63	3.43	0.20	16.12	86.62	1.36	1.40	1.36
630	3.62	3.46	0.17	16.16	86.85	1.36	1.40	1.37
650	3.60	3.50	0.11	16.18	87.12	1.36	1.41	1.38
670	3.57	3.56	0.01	16.19	87.43	1.37	1.41	1.39
690	3.53	3.64	0.11	16.19	87.77	1.37	1.43	1.40
710	3.48	3.74	0.27	16.17	88.15	1.38	1.44	1.42
730	3.41	3.87	0.46	16.13	88.60	1.40	1.46	1.45
750	3.33	4.03	0.70	16.07	89.12	1.41	1.48	1.48

1. Total Loss = Insertion Loss + 3 dB splitter loss.



NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html



2 Way-90° Power Splitter/Combiner

QCN-8+

Typical Performance Data

FREQ. (MHz)	TOTAL LOSS ¹		AMP. UNBAL. (dB)	ISOLATION (dB) 1-2	PHASE UNBAL. (Deg.)	FREQ. (MHz)	VSWR		
	(dB)						(:1)		
	S-1	S-2					S	1	2
450.0	3.27	3.76	0.49	15.68	85.22	450.0	1.41	1.41	1.38
455.0	3.30	3.74	0.44	15.69	85.26	455.0	1.40	1.41	1.38
460.0	3.32	3.71	0.40	15.70	85.29	460.0	1.40	1.41	1.38
465.0	3.34	3.69	0.35	15.71	85.34	465.0	1.40	1.41	1.38
470.0	3.36	3.67	0.31	15.72	85.37	470.0	1.40	1.41	1.37
490.0	3.43	3.59	0.16	15.78	85.50	490.0	1.39	1.41	1.37
510.0	3.49	3.53	0.04	15.84	85.66	510.0	1.39	1.40	1.36
530.0	3.54	3.48	0.06	15.90	85.83	530.0	1.38	1.40	1.36
550.0	3.58	3.45	0.13	15.95	86.00	550.0	1.37	1.40	1.36
570.0	3.61	3.43	0.18	16.01	86.18	570.0	1.37	1.40	1.36
590.0	3.63	3.42	0.20	16.07	86.37	590.0	1.36	1.40	1.36
610.0	3.63	3.43	0.20	16.12	86.62	610.0	1.36	1.40	1.36
630.0	3.62	3.46	0.17	16.16	86.85	630.0	1.36	1.40	1.37
650.0	3.60	3.50	0.11	16.18	87.12	650.0	1.36	1.41	1.38
670.0	3.57	3.56	0.01	16.19	87.43	670.0	1.37	1.41	1.39
690.0	3.53	3.64	0.11	16.19	87.77	690.0	1.37	1.43	1.40
710.0	3.48	3.74	0.27	16.17	88.15	710.0	1.38	1.44	1.42
730.0	3.41	3.87	0.46	16.13	88.60	730.0	1.40	1.46	1.45
750.0	3.33	4.03	0.70	16.07	89.12	750.0	1.41	1.48	1.48

¹Total Loss = Insertion Loss + 3dB Splitter Loss



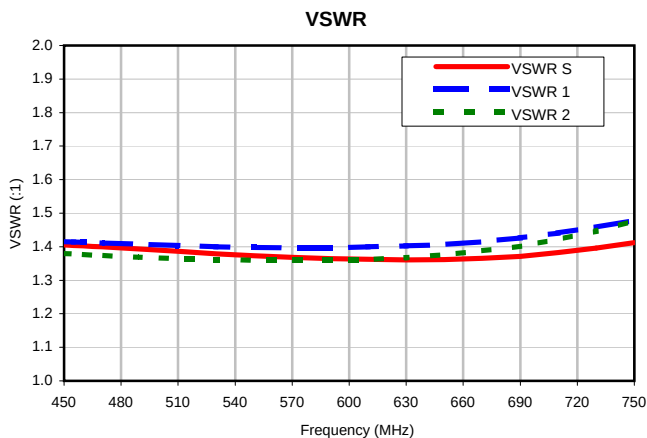
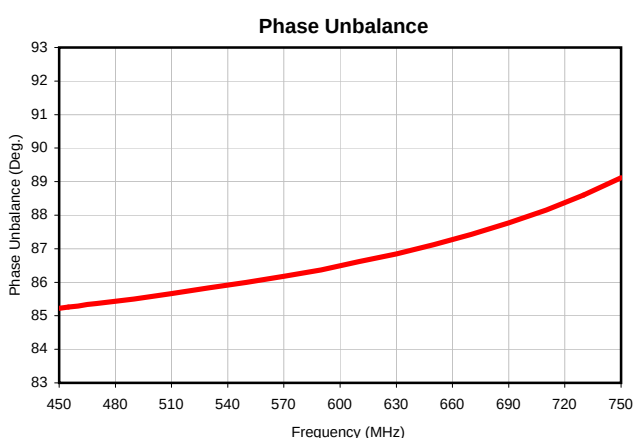
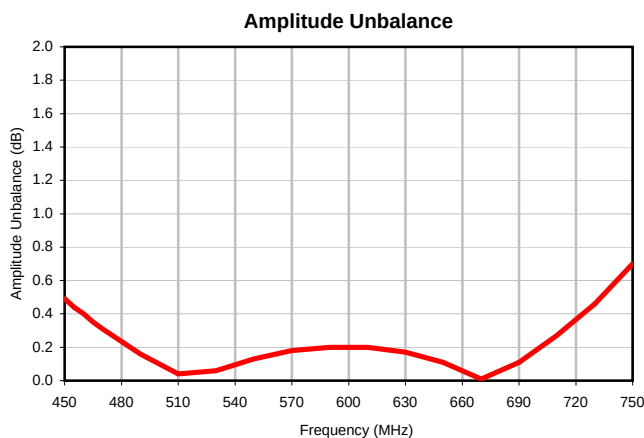
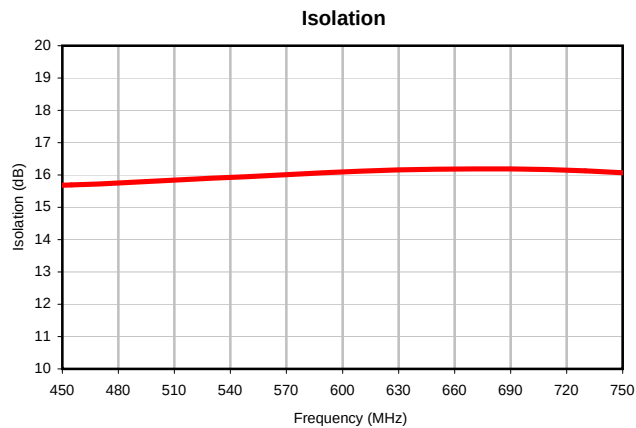
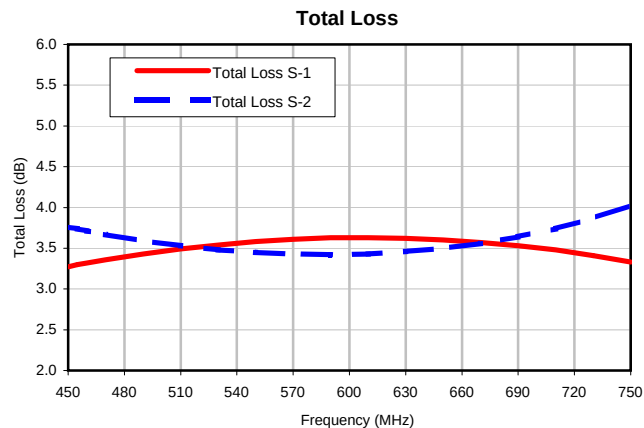
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 • Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site
 The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com



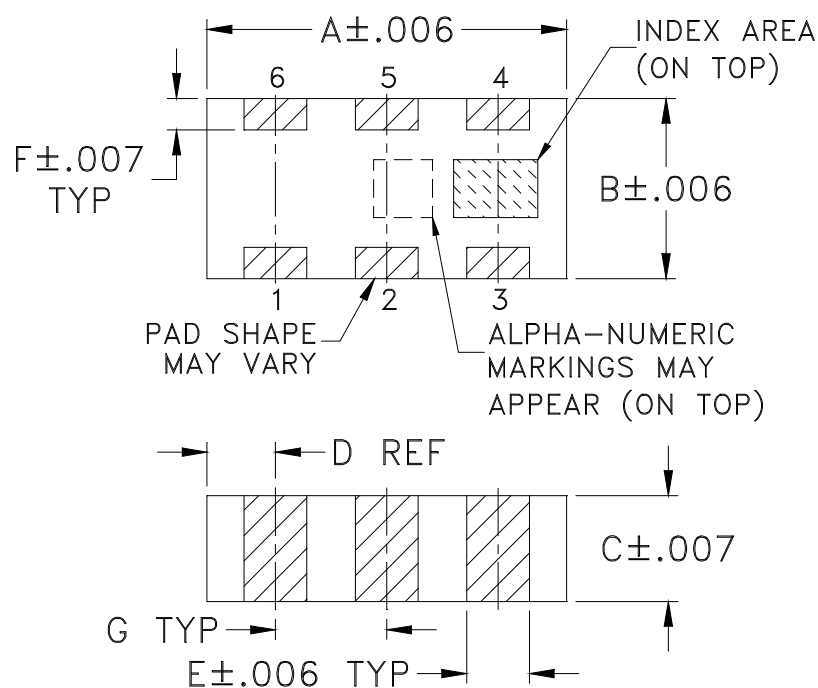
IF/RF MICROWAVE COMPONENTS

REV. X2
 QCN-8+
 8/4/2010
 Page 1 of 1

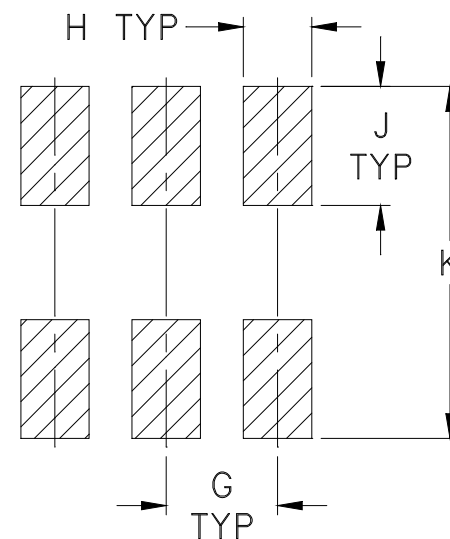
Typical Performance Curves



Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L	M	N	P	WT. GRAM
FV1206-1	.126 (3.20)	.063 (1.60)	.035 (0.89)	.024 (0.61)	.022 (0.56)	.011 (0.28)	.039 (0.99)	.024 (0.61)	.042 (1.07)	.123 (3.12)	--	--	--	--	.020

Dimensions are in inches (mm). Tolerances: 2 PL. $\pm .01$; 3 PL. $\pm .005$

Notes:

- Open style, ceramic base.
- Termination finish: **as shown below or indicated on Data Sheet.**
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



ISO 9001 ISO 14001 CERTIFIED

P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

DEVICE ORIENTATION IN T&R

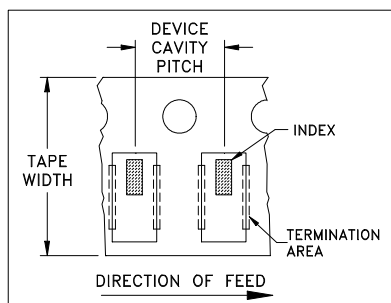


ILLUSTRATION 1

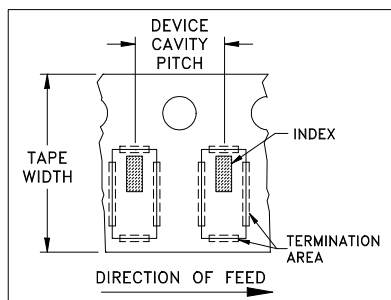


ILLUSTRATION 2

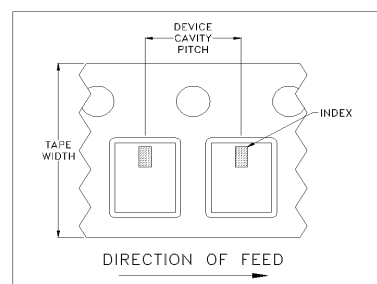


ILLUSTRATION 3

Applicable Case Styles

FV1206-1
FV1206-3

Applicable Case Styles

FV1206-4
FV1206-5
FV1206-6
FV1206-7
FV1206-9

Applicable Case Styles

FV1206-11
FV1206-12
GE0805C-18
NL1008C-6
NL1008C-7
NL1008C-9
NL1008C-10
NL1008C-12

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	3000

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

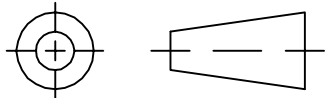


Distribution Centers NORTH AMERICA 800-654-7949 • 417-335-5935 • Fax 417-335-5945 • **EUROPE** 44-1252-832600 • Fax 44-1252-837010
Mini-Circuits ISO 9001 & ISO 14001 Certified

INTERNET <http://www.minicircuits.com>

P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661

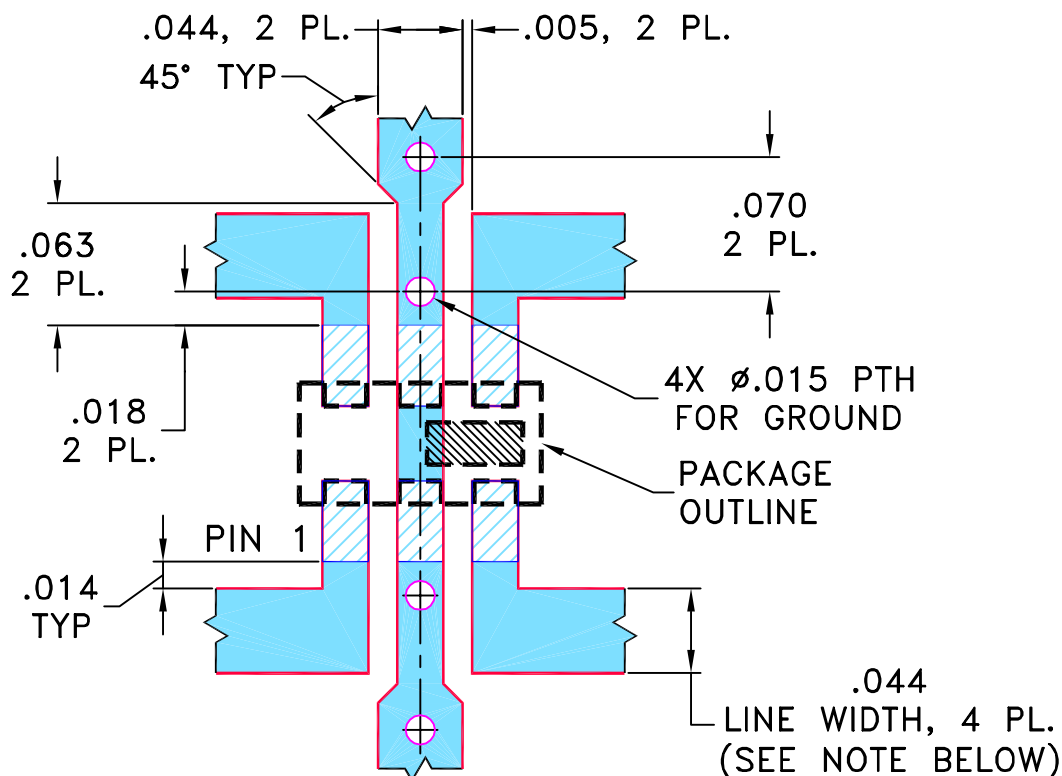
THIRD ANGLE PROJECTION



REVISIONS

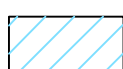
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M87001	NEW RELEASE	05/20/03	MMG	ABD
A	M87231	CORRECTED DWG.	05/28/03	MMG	ABD
B	M91636	ADDED "pn" PIN CONNECTION	04/07/04	AV	ABD
C	M102713	ADDED "...WITH SMOBC"	01/16/06	GF	IL

SUGGESTED MOUNTING CONFIGURATION
FOR FV1206-1 CASE STYLE, "pb/pn" PIN CONNECTIONS



NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS 0.020" $\pm$ 0.0015"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

-  DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
-  DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

TOLERANCES ON:

2 PL DECIMALS $\pm$ 3 PL DECIMALS $\pm$.005ANGLES $\pm$ FRACTIONS $\pm$

DRAWN

MMG

05/14/03

CHECKED

AV

05/19/03

APPROVED

ABD

05/20/03

 Mini-Circuits®

THIS DOCUMENT AND ITS CONTENTS ARE THE PROPERTY OF MINI-CIRCUITS. EXCEPT FOR USE EXPRESSLY GRANTED, IN WRITING, TO ITS VENDORS, VENDEE AND THE UNITED STATES GOVERNMENT, MINI-CIRCUITS RESERVES ALL PROPRIETARY DESIGN, USE, MANUFACTURING AND REPRODUCTION RIGHTS THERETO. THESE CONTENTS SHALL NOT BE USED, DUPLICATED OR DISCLOSED TO ANY OUTSIDE PARTY, IN WHOLE OR IN PART, WITHOUT WRITTEN PERMISSION OF MINI-CIRCUITS.

ASHEETA1.DWG REV:A DATE:01/12/95



Mini-Circuits®

13 Neptune Avenue
Brooklyn NY 11235

PL, pb/pn, FV1206-1, QCN/BDCN, TB-255

SIZE

CODE IDENT

DRAWING NO:

REV:

A

15542

98-PL-131

C

FILE:

98PL131

SCALE:

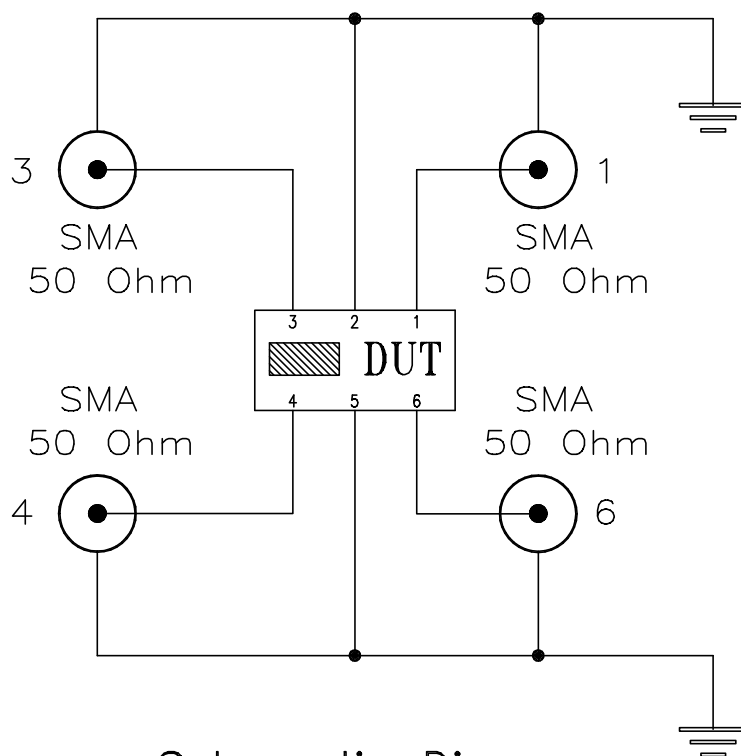
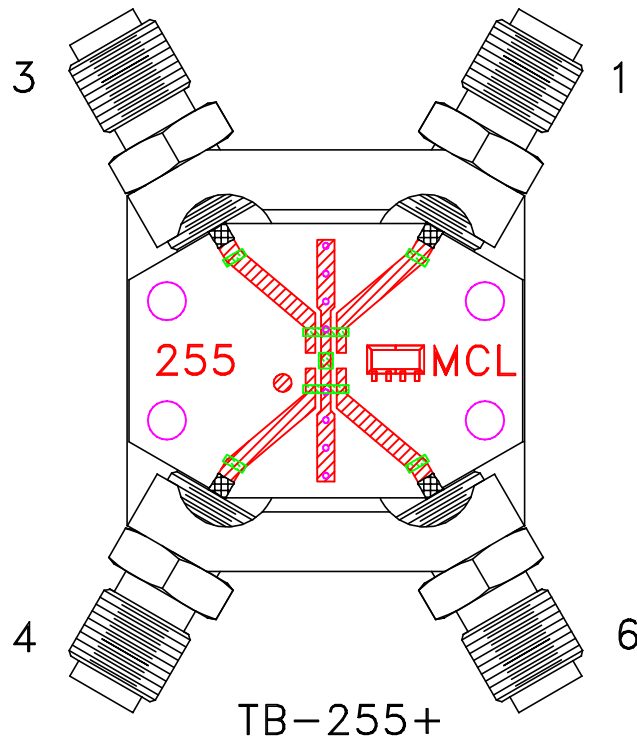
10:1

SHEET:

1 OF 1

Evaluation Board and Circuit

For Pin Connections refer to Data Sheet of the DUT



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent, Dielectric Constant=3.5, Thickness=.020 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A